

FDP045N10A_F102 / FDI045N10A_F102 N-Channel PowerTrench[®] MOSFET 100 V, 164 A, 4.5 mΩ

Features

- $R_{DS(on)} = 3.8 \text{ m}\Omega \text{ (Typ.)} \otimes V_{GS} = 10 \text{ V}, I_D = 100 \text{ A}$
- Fast Switching Speed
- Low Gate Charge, Q_G = 54 nC(Typ.)
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

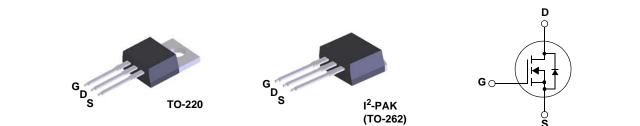
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor[®]'s advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

March 2013

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

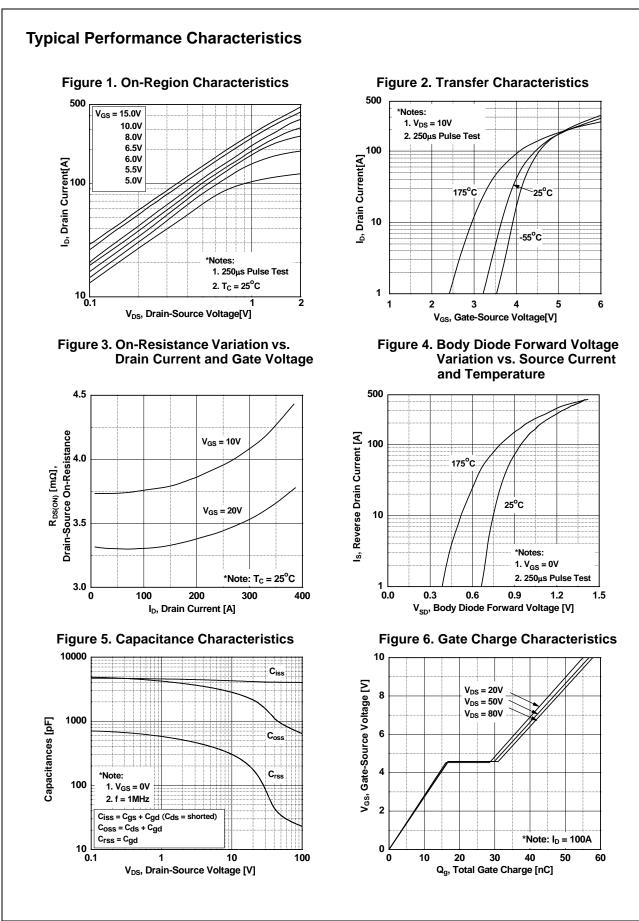
Symbol		FDP045N10A_F102 FDI045N10A_F102	Unit		
V _{DSS}	Drain to Source Voltage		100	V	
V _{GSS}	Gate to Source Voltage		±20	V	
I _D		- Continuous ($T_C = 25^{\circ}C$, Silicon	164*		
	Drain Current	- Continuous (T _C = 100 ^o C, Silicor	116	A	
		- Continuous (T _C = 25 ^o C, Packag	120		
I _{DM}	Drain Current	- Pulsed	(Note 1)	656	Α
E _{AS}	Single Pulsed Avalanche Energy	637	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns	
P _D	David Displaying the	$(T_{\rm C} = 25^{\rm o}{\rm C})$		263	W
	Power Dissipation	- Derate above 25°C	1.75	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

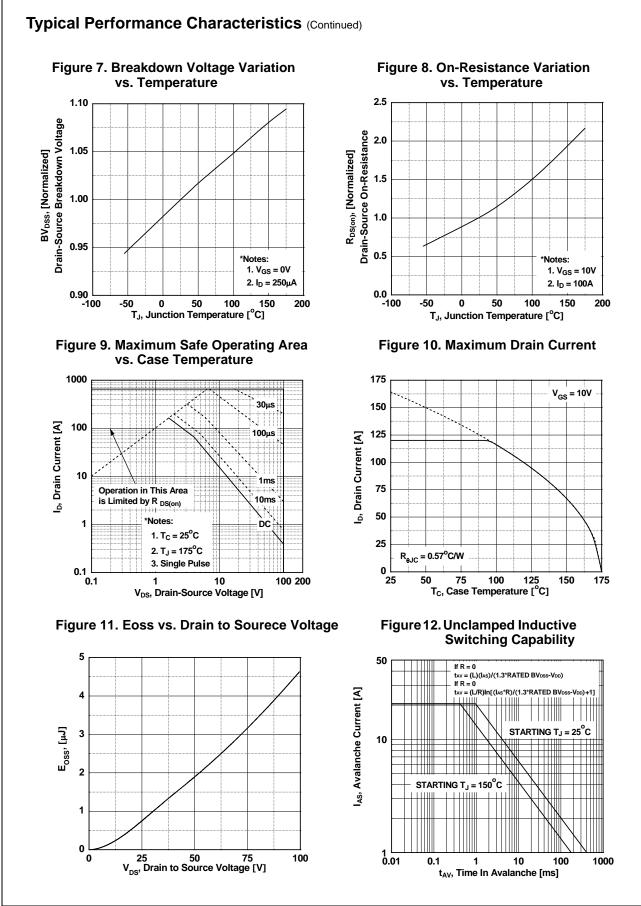
*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

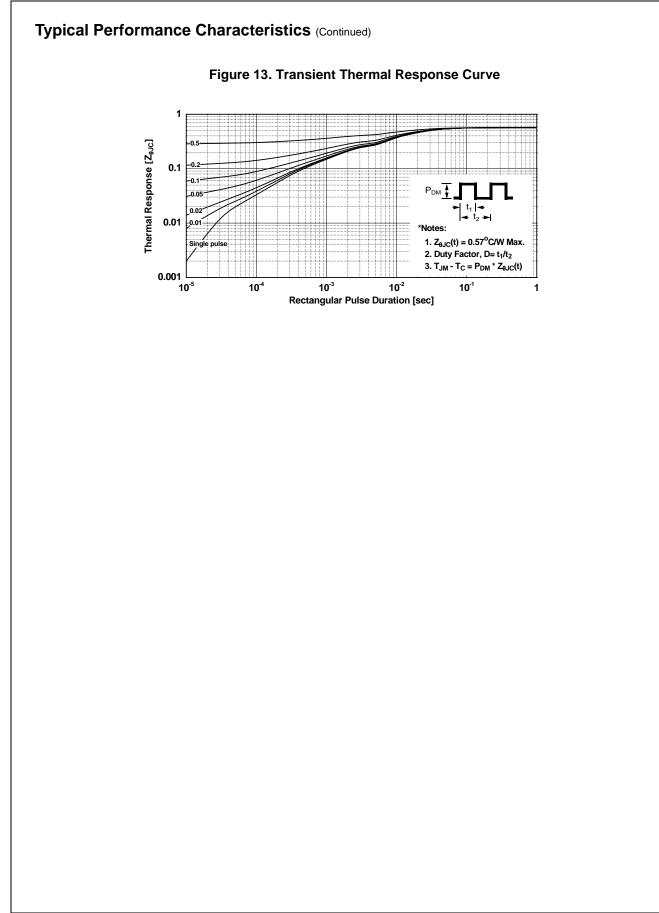
Thermal Characteristics

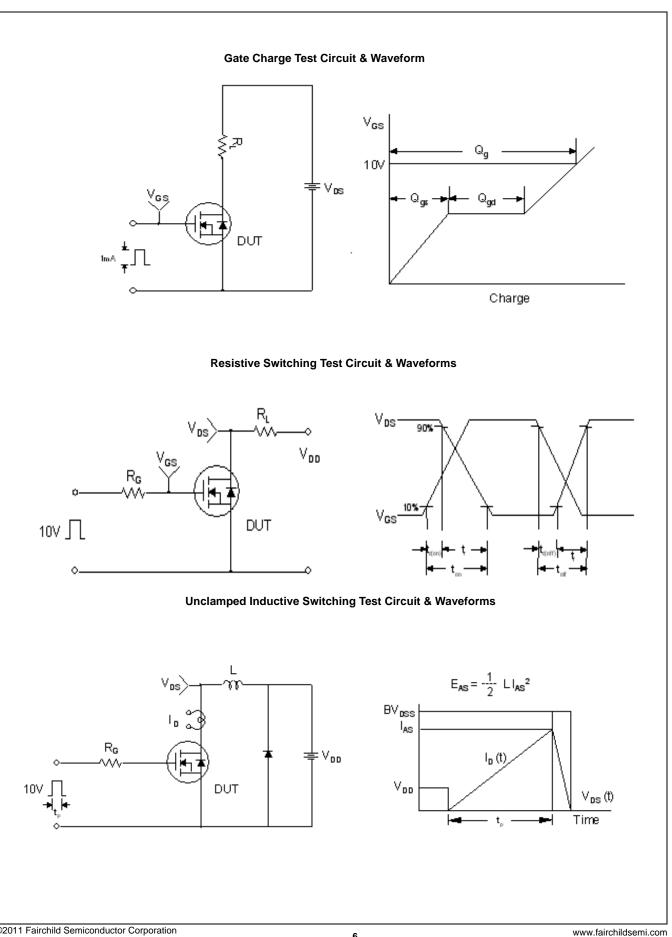
Symbol	Parameter	FDP045N10A_F102 FDI045N10A_F102	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.57	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	-0/10	

Device Marking		Device	Packag	e	Reel Size	Тар	e Width		Quantity	у
FDP045	FDP045N10A FDP045N10A_F102 TO-		TO-220	0	-		-		50	
FDI045N10A FDI045N10A_F102 I2P		I2PAK		-		-		50		
Electrica	l Cha	racteristics T _c = :	25ºC unless	otherwise	noted					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit	
Off Charac	teristi	cs								
BV _{DSS}	Drain t	to Source Breakdown Voltage		$I_{D} = 250 \mu A, V_{GS} = 0 V$			100	-	-	V
ΔBV _{DSS} ΔT _J	Break	kdown Voltage Temperature		$I_D = 250\mu$ A, Referenced to 25° C			-	0.07	-	V/°C
		Zero Gate Voltage Drain Current		$V_{DS} = 80V, V_{GS} = 0V$ $V_{DS} = 80V, T_{C} = 150^{\circ}C$			-	-	1	
I _{DSS}	∠ero G						-	-	500	μA
I _{GSS}	Gate to	o Body Leakage Current		-	$0V, V_{DS} = 0V$		-	-	±100	nA
On Charac										1
V _{GS(th)}	Gate Threshold Voltage			$V_{CS} = V_{CS}$	_{DS} , I _D = 250μA		2.0	-	4.0	V
R _{DS(on)}		c Drain to Source On Resistance			IV, I _D = 100A		-	3.8	4.5	mΩ
9 _{FS}		rd Transconductance			IV, I _D = 100A		-	132	-	S
Dynamic C	haract	teristics								
C _{iss}	Input C	Capacitance		V _{DS} = 50V, V _{GS} = 0V f = 1MHz		-	3960	5270	pF	
C _{oss}	Output	Capacitance				-	925	1230	pF	
C _{rss}		se Transfer Capacitance				-	34	-	pF	
C _{oss} (er)		Releted Output Capacitance		V _{DS} = 50V, V _{GS} = 0V			-	1520	-	pF
Q _{g(tot)}		Sate Charge at 10V		$V_{GS} = 10V, V_{DS} = 50V$			-	54	74	nC
Q _{gs}		to Source Gate Charge Charge Threshold to Plateau to Drain "Miller" Charge		$I_{\rm D} = 100{\rm A}$		-	17	-	nC	
Q _{gs2}				(Note 4)			-	8	-	nC
Q _{gd}							-	13	-	nC
Switching										
t _{d(on)}		on Delay Time		$V_{DD} = 50V, I_D = 100A$ $V_{GS} = 10V, R_{GEN} = 4.7\Omega$ (Note 4)		-	-	23	56	ns
t _r		n Rise Time				F	-	26	62	ns
t _{d(off)}		off Delay Time				F	-	50	110	ns
t _f		off Fall Time	<u> </u>			(Note 4)	-	15	40	ns
ESR	Equiva	lent Series Resistance (G-S)	f = 1MHz			-	1.9	-	Ω
Drain-Sou		de Characteristics							1	
I _S		um Continuous Drain to					-	-	164*	A
I _{SM}		num Pulsed Drain to Source Diode Fo					-	-	656	A
V _{SD}		to Source Diode Forward Voltage		$V_{GS} = 0V, I_{SD} = 100A$			-	-	1.3	V
t _{rr}		e Recovery Time			′, V _{DD} = 50V, I _{SD} =	= 100A	-	75	-	ns
Q _{rr}	Revers	e Recovery Charge		dl _F /dt = 100A/µs		-	120	-	nC	



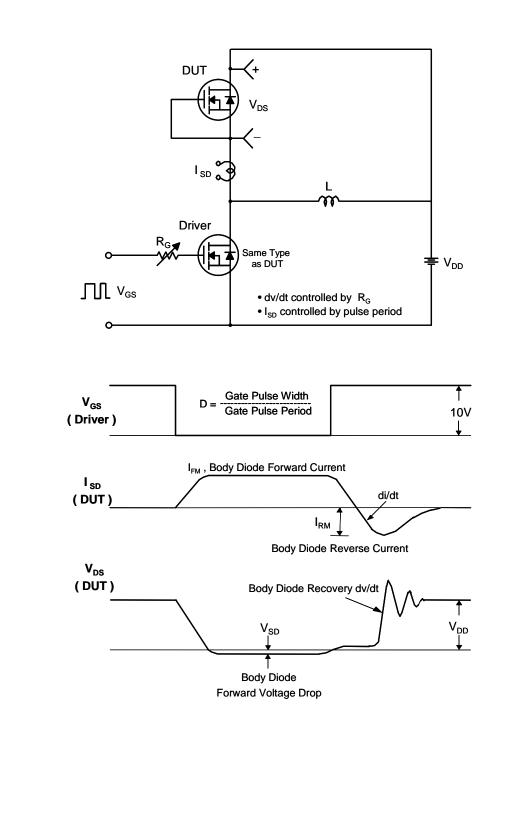


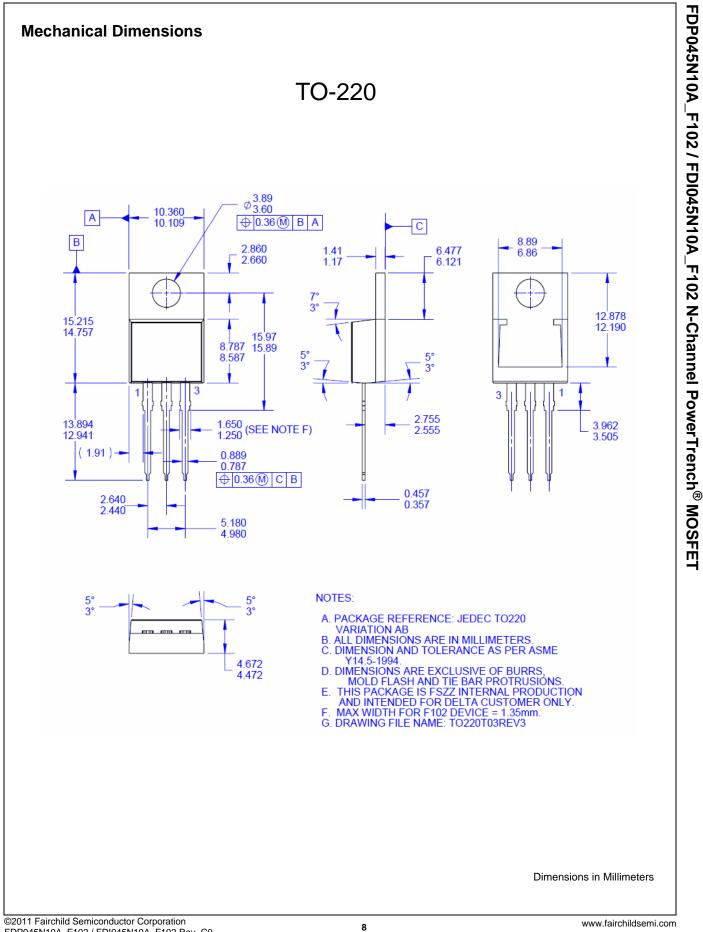


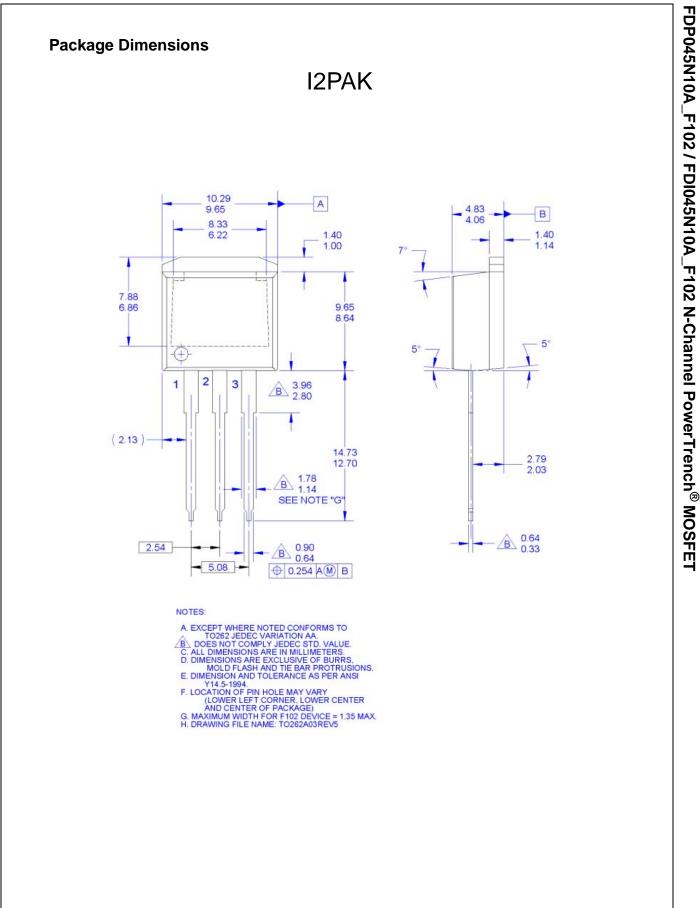


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Peak Diode Recovery dv/dt Test Circuit & Waveforms









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